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For: Electrical Contact Assembly With Insulative Carrier,
Stapled Contact Attachment And Fusible Element

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Electrical Contact Assembly With Insulative Carrier, Stapled Contact Attachment And Fusible Element

BACKGROUND OF THE INVENTION

1. Field of the Invention

[0001] The present invention relates to an electrical connector and, more particularly, to an electrical connector with deflectable contacts and fusible elements.

2. Brief Description of Prior Developments

[0002] U.S. Patent No. 6,193,523 discloses a contact for an electrical connector with a mounting portion for a solder ball. U.S. Patent No. 6,217,348 discloses an electrical connector with an upwardly extending contact section and a solder ball. Various other patents disclose land grid array connectors which use solder balls and deflectable spring arms, such as U.S. Patent Nos. 6,179,624 and 5,772,451 for example.

[0003] There is a continuing desire in the area of land grid array connectors to reduce the footprint size of the connectors, or increase contact density for a predetermined footprint size. Furthermore, the length of a spring feature in a contact in a land grid array connector still needs to be long enough and the spring powerful enough to provide certain predetermined contact force requirements. The contact also preferably provides a wiping feature when making contact with another electrical component.

[0004] Manufacturing of small electrical contacts by use of a forming operation can results in contacts being manufactured with inconsistent dimensions because of

variations in thickness of the stock material. The problem due to stock material thickness can be multiplied in contacts which comprise multiple bends to be formed during the forming operation. This can result in the manufacture of contacts which do not meet predetermined specifications. This can be especially detrimental in small size contacts, such as contacts used in land grid array connectors having 800 or more contacts in a 1 mm x 1 mm grid which are mounted in a housing which is only about 42 mm square.

[0005] There is a desire to provide a land grid array connector which can use ball grid array technology and which also comprises a greater density of electrical contacts than previously available. However, electrical need to contacts of the connector still provide sufficient contact force, contact wiping, and stability to be commercially marketable as a dependable product with a reasonably long working life. Such a connector also needs to be manufacturable at a reasonable, marketable cost in order to be commercially acceptable to customers.

SUMMARY OF THE INVENTION

[0006] In accordance with one aspect of the present invention, an electrical contact assembly is provided including a contact terminal and a fusible element. The contact terminal has a base and two cantilevered deflectable contact arms extending from at least one lateral side of the base. A first one of the contact arms extends in a downward direction and a second one of the contact arms extends in an upward direction. The fusible element is fixedly attached to an end of the

first contact arm. The fusible element is adapted to be fused to a first pad on a first electronic component. The second contact arm comprises a surface contact area for contacting a second pad on a second electronic component. The first and second contact arms are adapted to deflect when the fusible element is fused to the first electronic component and when the contact area of the second contact arm is contacted by the second pad of the second electronic component.

In accordance with another aspect of the present [0007] invention, an electrical connector subassembly provided comprising a carrier comprising electrically insulative material; and a plurality of electrical contact terminals connected to the carrier. terminal comprises a base and at least two deflectable contact arms extending from at least one lateral side of the base. The carrier comprises apertures. At least one of the contact arms of each terminal extends through a The base of each respective one of the apertures. terminal comprises tabs which are deformed to form a stapled connection of the base with the carrier.

[0008] In accordance with one method of the present invention, a method of assembling an electrical contact assembly is provided comprising steps of providing a contact terminal comprising a base and two cantilevered deflectable contact arms extending from a same lateral side of the base, a first one of the contact arms extending in an upward direction and a second one of the contact arms extending in a downward direction; and attaching a fusible element to an end of the second contact arm.

BRIEF DESCRIPTION OF THE DRAWINGS

- [0009] The foregoing aspects and other features of the present invention are explained in the following description, taken in connection with the accompanying drawings, wherein:
- [0010] Fig. 1 is a exploded perspective review of an electrical connector incorporating features of the present invention shown attached to a portion of a printed circuit board and adapted to receive an electronic component;
- [0011] Fig. 2 is a partial cross sectional view of the electrical connector shown in Fig. 1;
- [0012] Fig. 3 is a perspective view of the contact and fusible element shown in Fig. 2 shown attached to a carry strip before attachment to the carrier;
- [0013] Fig. 4 is a partial cross sectional view of the electrical connector as shown in Fig. 2 shown attached to two electronic components;
- [0014] Fig. 5 is a partial perspective view of the carrier shown in Fig. 2;
- [0015] Fig. 6 is a partial enlarged perspective view of the carrier shown in Fig. 5; and
- [0016] Fig 7 is a partial perspective view similar to Fig. 3 of an alternate embodiment of the attachment of the fusible element to an electrical contact.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

Referring to Fig. 1, there is shown a perspective view of an electrical connector 10 incorporating features of the present invention shown attached to a first electronic component 12, such as a printed circuit board (PCB), and adapted to receive а second electronic component 14, such as a processor chip. The connector 10 adapted to electrically attach the electronic component 14 to the printed circuit board 12. the present invention will be described with reference to the exemplary embodiments shown in the drawings, should be understood that the present invention can be embodied in many alternate forms of embodiments. In addition, any suitable size, shape or type of elements or materials could be used.

[0018] The present invention can address the need for an electrical connection between two pads, such as in the case of connecting a land grid array (LGA) package to a pad on a PCB. The present invention can provide an optimized design to be configured into an array for high-density and high I/O counts. This optimized design can provide superior electrical performance from a short electrical path provided by the contact geometry. The short contact geometry also provides a low mated height.

[0019] The contact can consist of a spring having two spring beams, one formed up and the other formed down, and a carrier that provides a support for positioning the contacts. The contacts can be attached to the carrier by a feature on the contact, similar to a staple, that protrudes through the carrier and is then formed against the carrier to secure the contact to the carrier. One

spring beam can have a solder ball attached to its tip. The spring beams can be designed to accommodate a torsional deflection and additional wipe of the upper beam contact created by the offset position of the spring beam relative to each other.

[0020] The contacts can be held in place by the contact staple feature attached to the insulating carrier with apertures in the carrier allowing the spring beams to protrude through one side of the carrier to make contact with the associated mating components when positioned and compressed. Assembly of multiple contacts allows for various array configurations determined by the mating component and assembly patterns. This design leads itself to rapidly producing multiple different contact configurations. A frame could be added to the carrier to provide mechanical stiffness to the contact pattern for ball grid array (BGA) placement and attachment.

[0021] Referring also to Figs. 2 and 3, the electrical connector 10 comprises a housing 16 and at least one electrical connector subassembly 17. The electrical connector subassembly 17 generally comprises electrical contacts 18, a carrier 19, and fusible elements 20. 2 shows the electrical connector 10 before the electrical connector is attached to the PCB 12 and before the second electronic component 14 is attached to the connector. shows the electrical connector 10 after component attached thereto electronic 14 is compression means (not shown). The electrical connector 10 generally comprises a first side 90 which is adapted to function as a land grid array (LGA) connection and a second side 92 which is adapted to function as a ball grid array (BGA) connection.

[0022] The first electronic component 12, in the embodiment shown, comprises contact pads 23 on a top side thereof. In the embodiment shown, the contact pads 23 comprise solder pads. The contact pads 23 are adapted to have the fusible materials, such as solder balls 20, fused thereonto. The second electronic component 14, in the embodiment shown, comprises contact pads 22 on a bottom side thereof. The contact pads 22 are adapted to contact the electrical contacts 18 in a general land grid array type of connection.

[0023] As seen most clearly in Figs. 2 and 4, portions of the electrical contacts 18 extend above and below the housing 16. The portions of the electrical contacts 18 can be deflected or moved towards the housing 16 by the second electronic component 14 when the second electronic component is attached to the electrical connector 10.

[0024] The housing 16 is comprised of electrically insulating material. In the embodiment shown, housing 16 generally comprises a first member 26 and a second member 28. The first and second members 26, 28 form a plurality of electrical contact receiving areas As seen in Fig. 1, the electrical contact receiving areas 24 are arranged in an array of parallel columns and In this embodiment, the array has a parallel rows. ring shape. However, in alternate general square embodiments, any suitable type of array could provided.

[0025] The receiving areas 24 each comprise a first section 30, a second section 32 and a middle section 36. The first section 30 is located in the first member 26. The second section 32 is located in the second member 28.

The middle section 36 is located in both the first and second members 26, 28 or may be located entirely within one of the members 26, 28. The middle section 36 is located at a junction between the first members 26, 28 and connects the first section 30 to the second section 32. The first and second sections 30, 32 are at least partially offset from each other as seen in Fig. 2.

[0026] The subassembly 17 is also located at the junction between the first and second members 26, 28. noted above, the subassembly 17 generally comprises the electrical contacts 18, the carrier 19, and the fusible Referring also to Figs. 5 and 6, elements 20. carrier 19 preferably comprises a sheet of electrically insulative material. In this embodiment, the sheet 19 comprises a plurality of main apertures 38 plurality of staple slots 40. Each main aperture 38 comprises a pair of the staple slots 40 at one end thereof. The carrier 19 can be comprised of any suitable type of electrically insulative film material, such as KAPTON™. In a preferred embodiment, the carrier 19 is about 0.003 - 0.005 inches thick. The carrier 19 is preferably flexible. The carrier 19 adds stiffness to the contact 18.

[0027] Referring particularly to Fig. 3, one of the electrical contacts 18 is shown. The electrical contact 18 is shown still attached to its carry strip 42. The carry strip 42 would be removed before, during or after connection of the contact 18 to the carrier 19. In the electrical embodiment shown, the contacts 18 substantially identical to each other. However, alternate embodiments, the electrical connector 10 could comprise different types of electrical contacts. The

electrical contact 18 is preferably comprised of flat sheet metal material, such as a copper alloy for example, which has been stamped and/or formed into the shape shown. The contact 18 can be plated with additional material, such as nickel and gold for example. In a preferred embodiment, the thickness or width 34 of the contact 18 is about 0.15 mm. However, in alternate embodiments, any suitable type of thickness or width could be provided.

[0028] The electrical contact 18 generally comprises a base 44 and two cantilevered, resiliently deflectable, contact arms 46, 48 extending from a same lateral side 50 of the base 44. The first contact arm 46 extends in a downward direction. The second contact arm 48 extends in an upward direction. An end 52 of the first contact arm 46 forms a fusible element attachment section. embodiment shown, the end 52 comprises a concave shaped bottom side 54 which forms a recess or pocket receiving a portion of the solder ball 20. However, in an alternate embodiment, the recess in the bottom side 54 might not be provided and, the recess might An end 56 of the second contact arm comprises a top surface 58 which forms a contact surface. In a preferred embodiment, the top surface 58 is stamped to form a curved surface. Preferably, the curved top surface 58 comprises a compound curvature. However, alternate embodiments, the top surface 58 could comprise any suitable type of contact surface shape. The first contact arm 46 extends downward and the second contact arm 48 extends upward generally parallel to each other as shown by centerlines 62 and 64 in Fig. 2. The centerlines 62, 64 are offset from each other.

[0029] The base 44 of the contact 18 includes an aperture 45 which is provided to increase the flexibility of the contact arms 46, 48 without increasing the length of the contact arms. However, the aperture 45 decreases the stiffness or rigidity of the base 44. By attaching the base 44 to the carrier 19, the carrier 19 is able to add stiffness to the base 44.

The base 44 also includes two cantilevered side [0030] tabs 60. The side tabs 60 are used as mounting means for attaching the contact 18 to the carrier 19. More particularly, the tabs 60 are deformed to extend through the staple slots 40 in the carrier 19 and back towards the main section of the base 44 as shown in Fig. 2 in a stapled mounting configuration. Thus, the base captures a portion of the carrier 19 thereto by a staple mounting procedure. When the contact 18 is attached to the carrier 19 the second contact arm 48 is able to extend through one of the apertures 39. The apertures 39, thus, provide a clearance hole for the second contact The slots 40 might not be provided before the staple mounts are attached, such as when the staple mounts pierce through the carrier 19. The staple mounts comprise the tabs 60 being bent towards each other and then inward towards the base 44 to capture portions of the carrier between outer ends of the tabs 60 and the base 44. In alternate embodiments, other forms of staple mounting could be provided. Alternatively additionally, any other suitable form of attaching the contacts to the carrier could be provided.

[0031] The fusible elements 20, generally comprise solder balls. A top side of each solder ball 20 is fused to the concave bottom side 54 of the first contact arm

46, by reflow techniques using solder paste or solder flux. The fusible elements 20 are preferably attached to the contacts 18 before the contacts are attached to the carrier 19.

[0032] With the subassembly 17 assembled, subassembly is then assembled with the housing 16. subassembly 17 is located such that the carrier 19 located at the junction between the first and second The base 44 is also located at the members 26, 28. junction between the first and second members 26, 28 in the middle section 36 of the contact receiving area 24. The first and second members 26, 28 can be fixedly attached to each other by any suitable means. type of embodiment, adhesive layers between the first and second members and the carrier 19 hold the elements of the housing together. In another type of embodiment, the members 19, 26, 28 could be ultrasonically welded to each other.

[0033] The first contact arm 46 extends from the middle section 36 through the first section 30 of the contact receiving area 24 and past the bottom of the housing 16. The first contact arm 46 is deflectably movable in the first section 30. The second contact arm 48 extends from the middle section 36 through the second section 32 of the contact receiving areas 24 and past the top of the housing 16. The second contact arm 48 is deflectably movable in the second section 32.

[0034] Referring particularly to Fig. 4, the electrical connector 10 would be attached to the first electronic component 12 before the second electronic component 14 is secured onto the component 12. When the connector 10 is

attached to the first electronic component 12 the fusible element 20 is placed against the pad 23. The fusible element 20 is then melted, such as in a solder reflow heating process, to allow the fusible element 22 to fuse with the pad 23 and form a fixed stationery electrical and mechanical connection therebetween. The contact arms 48 of the many contacts 18 will deflect outward different amounts due to different sizes of the solder balls 20 before melting, such as due to tolerance variations of the solder balls, and different sizes and shapes of the contact arms 48 due to tolerance variations.

[0035] Once the electrical connector 10 is attached to the first electronic component 12, the second electronic component 14 can be removably connected to the connector 10. When the second electronic component 14 is attached to the connector 10, the contact pads 22 press against the contact surfaces 58 on the second contact arms 48. Because the centerline axis 64 of the second contact arm 48 is offset by a distance 66 from the center line axis 62 of the first contact arm 46, there is provided a torsional bending of at least the second contact arm 48, and perhaps the base 44 and/or first contact arm 46, during deflection by contact with the pads 22 against the contact surfaces 58. This torsional deflection provides an additional wipe of the contact surface 58 against the pads 22 to be created by the offset position of spring beams 46, 48 relative to each other. The clamping structure which presses the second component 14 towards the first component 12 causes both the arms 46, 48 to deflect in generally opposite directions towards the base 44. This structure increases the height of available deflection by using area both above and below the base 44 and, increases the normal force against the pads 22 because of the use of both arms 46, 48 to deflect.

[0036] In an alternate embodiment, the staple slots 40 might not be provided in the carrier 19 before the contacts 18 are attached to the carrier. Instead, staple slots could be formed during connection of the In contacts 18 to the carrier 19. an alternate embodiment, the carrier 19 could comprise any suitable thickness. The carrier 19 could be rigid or semi-rigid. another alternate embodiment, the carrier comprise a laminated structure with multiple layers, such layer of stainless steel laminated with electrically insulative isolator, such as comprised of KAPTON™. In another alternate embodiment, any suitable type of method for attaching the contact to the carrier could be provided. Any suitable connection of fusible element to one of the contact arms could be Both of the contact arms could comprise provided. fusible elements attached thereto, such as for a nonremovable connection. The fusible elements could also be attached to the contacts after the contacts are attached to the carrier. In another alternate embodiment, the fusible elements 20 could be attached to the contacts 18 after the carrier 19 and contacts 18 are assembled with the housing 16.

[0037] Referring now to Fig. 7, a partial perspective view of an alternate embodiment of the present invention is shown. In this embodiment the subassembly 70 generally comprises an electrical contact 72 and a fusible element 74. The electrical contact 72 is substantially identical to the electrical contact 18 shown in Fig. 3. However, the end 76 of the first

contact arm 78 does not comprise an inverted bowl shape as the end 52 shown in Fig. 3. In this embodiment, the end 52 extends into the fusible element. The fusible element 74 is located on the end 76 with the end 76 being located inside the fusible element 74. Thus, this embodiment illustrates that the fusible element 74 can be fused to the end 76 before attachment of the fusible element 74 to the contact pad on the printed circuit board. The subassembly 70 can be subsequently attached to a carrier, such as the carrier 19.

[0038] The present invention can provide a BGA to LGA or compressive beam connection that has an array with a high contact density, low inductance, high speed, and low cost manufacture. Because of the small size of the contacts, of the carrier helps to eliminate contact positioning problems in the housing during connector The use of the carrier in the assembly. present invention also helps to eliminate the small transporting problems found in assembly of conventional connectors having small contacts. The present invention provides greater manufacturing configuration flexibility by allowing the contacts to be connected to the carrier in any selected type of array design while still using the same contacts and carrier. The small height of the contacts help to reduce the height of the connector. The design also helps to reduce induction contact Torsional bending can be provided to enhance impedance. contact wipe.

[0039] It should be understood that the foregoing description is only illustrative of the invention. Various alternatives and modifications can be devised by those skilled in the art without departing from the

invention. Accordingly, the present invention is intended to embrace all such alternatives, modifications and variances which fall within the scope of the appended claims.